

**IN THE CLAIMS**

None of the claims has been amended. However, a complete set of the pending claims is reproduced below for convenient reference by the Examiner as follows:

1. (Previously Presented) A resistive element, comprising:
  - a first contact point connected to a capacitor terminal;
  - a second contact point connected to a circuit board plane; and
  - a resistive material connected to the first and second contact points, wherein a summed series resistance provided by adding a value of resistance for the resistive element to an effective series resistance of a capacitor including the capacitor terminal is approximately equal to an effective series resistance of a circuit board and the circuit board plane.
2. (Original) The resistive element of claim 1, wherein the first contact point is connected to the capacitor terminal using solder, and wherein the second contact point is connected to the circuit board plane using at least one via.
3. (Original) The resistive element of claim 1, wherein the resistive material includes a first metal.
4. (Original) The resistive element of claim 3, wherein the first metal is nickel.
5. (Original) The resistive element of claim 3, wherein the resistive material includes a second metal.
6. (Original) The resistive element of claim 5, wherein the second metal is gold.

7. (Original) The resistive element of claim 6, wherein the first and second metals have a width of about 10 to about 1000 microns, a length of about 10 to about 5000 microns, and a total thickness of about 0.05 to about 2.5 microns.
8. (Withdrawn) The resistive element of claim 1, wherein the resistive material includes a conductive epoxy.
9. (Withdrawn) The resistive element of claim 1, wherein the resistive material includes a resistive component selected from a group consisting of: a metal, a conductive metal oxide, a glass, a solvent, a polymer, nickel, chromium, tantalum, oxynitride, silicon monoxide, cobalt, alumina, sapphire, quartz, berillium, palladium, carbon, platinum, ruthenium, rhodium, and gold.
10. (Original) The resistive element of claim 1, wherein the second contact point is connected to the circuit board plane using a plurality of vias.

Claims 11. – 26. (Canceled)

27. (Previously Presented) An apparatus, including:
  - a circuit element including a capacitor; and
  - a resistive element including a first contact point connected to a terminal of the capacitor, a second contact point connected to a circuit board plane, and a resistive material connected to the first and second contact points, wherein a summed series resistance provided by adding a value of resistance for the resistive element to an effective series resistance of the capacitor is approximately equal to an effective series resistance of a circuit board and the circuit board plane.
28. (Withdrawn) The apparatus of claim 27, wherein the resistive material includes a conductive epoxy and a resistive component selected from a group consisting of: a metal, a conductive metal oxide, a glass, a solvent, a polymer, nickel, chromium, tantalum, oxynitride,

silicon monoxide, cobalt, alumina, sapphire, quartz, berillium, palladium, carbon, platinum, ruthenium, rhodium, and gold.

29. (Withdrawn) The apparatus of claim 27, wherein the circuit element includes at least one transistor.

30. (Previously Presented) The apparatus of claim 27, further including:  
an outside surface to which the resistive element is attached.

31. (Canceled)

32. (Previously Presented) The apparatus of claim 27, wherein the resistive material includes a first metal.

33. (Previously Presented) The apparatus of claim 32, wherein the first metal is nickel.

34. (Previously Presented) The apparatus of claim 32, wherein the resistive material includes a second metal.

35. (Previously Presented) The apparatus of claim 34, wherein the second metal is gold.